

LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S
INFORMATION DISCLOSURE STATEMENTApplicant:
Sang-Chul LEE

(Use several sheets if necessary)

Page 1 of 1

Filing Date:
ConcurrentlyGroup:
TBD

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

| EXAMINERS INITIALS | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE (IF APPRO.) |
|-----------------------|-----------------|---------|---------------|---------|----------|----------------------------|
| <i>cl</i> | US-5786239 | 07-1998 | Ohsawa et al. | 438/123 | | |
| <i>cl</i> | US-4502059 | 02-1985 | Blessington | 347/68 | | |
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FOREIGN PATENT DOCUMENTS

| | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | TRANSLATION | |
|-----------|-----------------|---------|---------|-------|----------|--------------------------|--------------------------|
| | | | | | | YES | NO |
| <i>cl</i> | JP402122993 | 05-1990 | Japan | | | <input type="checkbox"/> | <input type="checkbox"/> |
| <i>cl</i> | JP406082803A | 03-1994 | Japan | | | <input type="checkbox"/> | <input type="checkbox"/> |
| <i>cl</i> | JP2000258789A | 09-2000 | Japan | | | <input type="checkbox"/> | <input type="checkbox"/> |
| <i>cl</i> | JP404371921A | 12-1992 | Japan | | | <input type="checkbox"/> | <input type="checkbox"/> |
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OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

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EXAMINER

Hoon Nguyen

DATE CONSIDERED

9/25/04

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not conformance and not considered. Include copy of this form with next communication to applicant.